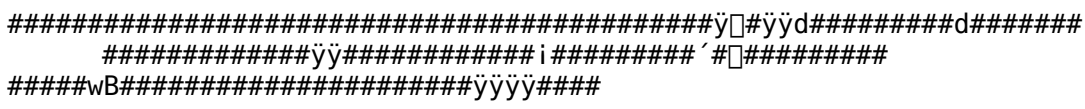

###ÿÿ#####ÿ□#ÿÿd#########d#########e###Custom IGBT Module - Slide No. 8Six 100 Amp TransistorsTwelve 75 Amp DiodesAluminum Nitride SubstrateMetal Matrix Composite Baseplate (Silicon Carbide/Aluminum)Designed for □blind mating□ connectionConnection strap is a dulctile copper containing a floating fastener - This allows a x/y radial float of .040 inches and a □z□ axis float of .060 inches#

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